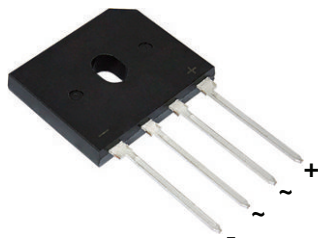
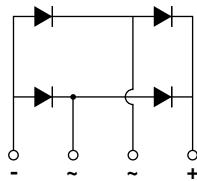


Single In-Line Bridge Rectifier



Case Style GBU



Case Style GBU

FEATURES

- UL recognition file number E312394
- Glass passivated chip junction
- Solder dip 275 °C max. 10 s, per JESD 22-B106
- Ideal for printed circuit boards
- High surge current capability
- High case dielectric strength of 2000 V_{RMS}, 1 minute
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912



RoHS
COMPLIANT
HALOGEN
FREE

TYPICAL APPLICATIONS

General purpose use in AC/DC bridge full wave rectification for switching power supply, home applications, and white-goods applications specially or telecom power supply, game PC

MECHANICAL DATA

Case: GBU

Molding compound meets UL 94 V-0 flammability rating

Base P/N-M3 - halogen-free, RoHS-compliant, and industrial grade

Terminals: matte tin plated leads, solderable per J-STD-002 and JESD22-B102

M3 suffix meet JESD 201 class 1A whisker test

Polarity: as marked on body

Mounting Torque: 10 cm-kg (8.8 inches-lbs) max.

Recommended Torque: 5.7 cm-kg (5 inches-lbs)

LINKS TO ADDITIONAL RESOURCES



3D Models

| PRIMARY CHARACTERISTICS | |
|----------------------------------|---------|
| $I_F(AV)$ | 25 A |
| V_{RRM} | 800 V |
| I_{FSM} | 350 A |
| V_F at $I_F = 12.5$ A (125 °C) | 0.86 V |
| T_J max. | 175 °C |
| Package | GBU |
| Circuit configuration | In-line |

| MAXIMUM RATINGS ($T_A = 25$ °C unless otherwise noted) | | | |
|---|----------------|-------------|------------------|
| PARAMETER | SYMBOL | GBU25H08 | UNIT |
| Device marking code | | GBU25H08 | |
| Maximum repetitive peak reverse voltage | V_{RRM} | 800 | V |
| Maximum RMS voltage | V_{RMS} | 560 | V |
| Maximum DC blocking voltage | V_{DC} | 800 | V |
| Maximum average forward rectified output current at | $T_C = 120$ °C | $I_O^{(1)}$ | A |
| | $T_A = 25$ °C | $I_O^{(2)}$ | |
| Non-repetitive peak forward surge current 8.3 ms single sine-wave, $T_J = 25$ °C | I_{FSM} | 350 | A |
| Non-repetitive peak forward surge current 1.0 ms single sine-wave, $T_J = 25$ °C | I_{FSM} | 700 | A |
| Rating for fusing ($t < 8.3$ ms) | I^2t | 508 | A ² s |
| Operating junction and storage temperature range | T_J, T_{STG} | -55 to +175 | °C |

Notes

(1) Unit case mounted on aluminum plate heatsink

(2) Units mounted on PCB without heatsink

| ELECTRICAL CHARACTERISTICS (T _J = 25 °C unless otherwise noted) | | | | | | |
|--|--|-------------------------|-------------------------------|------|------|------|
| PARAMETER | TEST CONDITIONS | | SYMBOL | TYP. | MAX. | UNIT |
| Maximum instantaneous forward voltage drop per diode | I _F = 12.5 A | T _J = 25 °C | V _F ⁽¹⁾ | 0.97 | 1.05 | V |
| | | T _J = 125 °C | | 0.86 | - | |
| Maximum DC reverse current at rated DC blocking voltage per diode | V _R = 800 V | T _J = 25 °C | I _R ⁽²⁾ | - | 10 | μA |
| | | T _J = 125 °C | | 45 | - | |
| Typical reverse recovery time | I _F = 0.5 A, I _R = 1.0 A, I _{rr} = 0.25 A | | t _{rr} | 3500 | - | ns |
| Typical junction capacitance per diode | 4.0 V, 1 MHz | | C _J | 100 | - | pF |

Notes

(1) Pulse test: 300 μs pulse width, 1 % duty cycle

(2) Pulse test: pulse width $\leq 40\text{ ms}$

| THERMAL CHARACTERISTICS ($T_A = 25\text{ }^{\circ}\text{C}$ unless otherwise noted) | | | |
|---|-----------------------|----------|----------------------|
| PARAMETER | SYMBOL | GBU25H08 | UNIT |
| Typical thermal resistance | $R_{\theta JA}^{(1)}$ | 24 | $^{\circ}\text{C/W}$ |
| | $R_{\theta JC}^{(2)}$ | 4 | |

Notes

(1) Without heatsink, free air

(2) With heatsink

| ORDERING INFORMATION | | | | |
|-----------------------------|-----------------|------------------------|---------------|---------------|
| PREFERRED P/N | UNIT WEIGHT (g) | PREFERRED PACKAGE CODE | BASE QUANTITY | DELIVERY MODE |
| GBU25H08-M3/P | 3.87 | P | 20 | Tube |

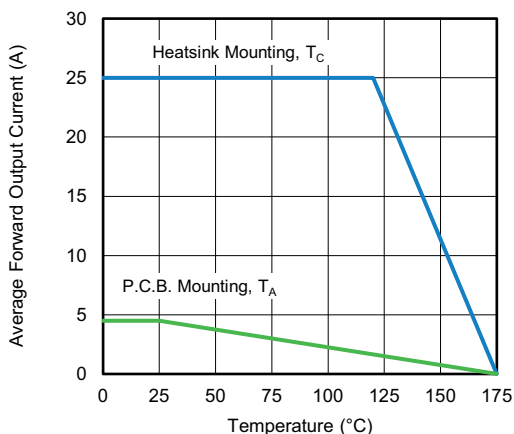
RATINGS AND CHARACTERISTICS CURVES ($T_A = 25\text{ }^{\circ}\text{C}$ unless otherwise noted)


Fig. 1 - Derating Curve Output Rectified Current

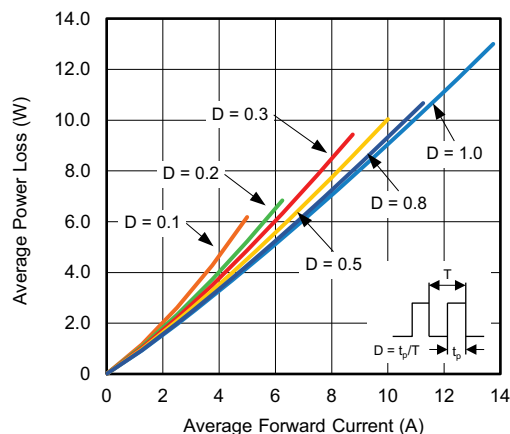


Fig. 2 - Maximum Non-Repetitive Peak Forward Surge Current Per Diode

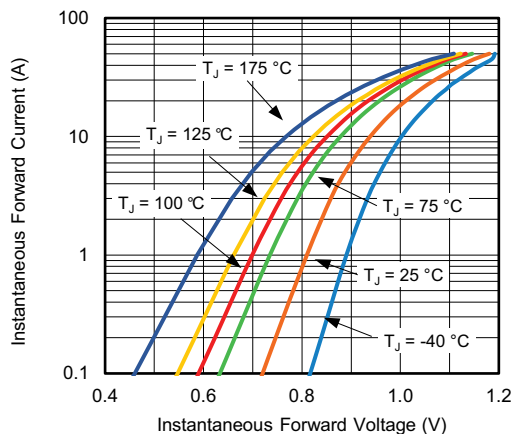


Fig. 3 - Typical Forward Characteristics Per Diode

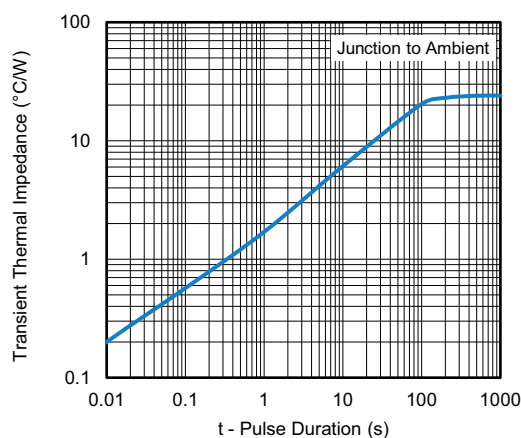


Fig. 6 - Typical Transient Thermal Impedance Per Diode

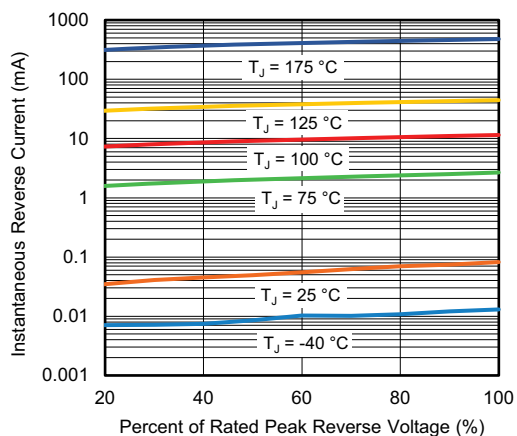


Fig. 4 - Typical Reverse Leakage Characteristics Per Diode

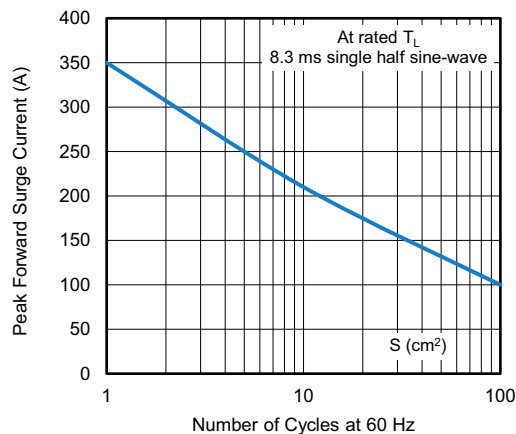


Fig. 7 - Peak Forward Surge Current

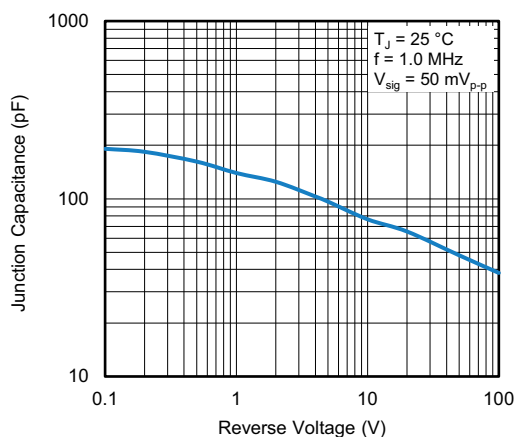
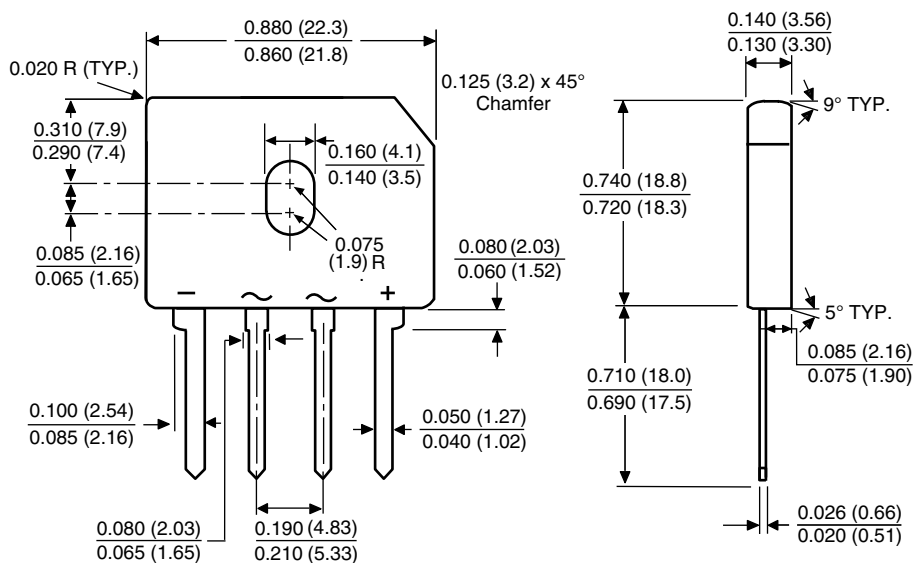


Fig. 5 - Typical Junction Capacitance Per Diode

PACKAGE OUTLINE DIMENSIONS in inches (millimeters)

GBU


Polarity shown on front side of case, positive lead by beveled corner



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